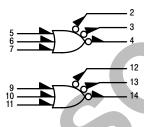
Dual 3-Input/3-Ouput NOR Gate

The MC10111 is designed to drive up to three transmission lines simul– taneously. The multiple outputs of this device also allow the wire "OR"-ing of several levels of gating for minimization of gate and package count.

The ability to control three parallel lines from a single point makes the MC10111 particularly useful in clock distribution applications where minimum clock skew is desired. Three V_{CC} pins are provided and each one should be used.

- $P_D = 80 \text{ mW typ/gate (No Load)}$
- $t_{pd} = 2.4 \text{ ns typ (All Outputs Loaded)}$
- t_r , $t_f = 2.2$ ns typ (20%–80%)

LOGIC DIAGRAM



 $V_{CC1} = PIN 1,15$ $V_{CC2} = PIN 16$ $V_{EE} = PIN 8$

DIP PIN ASSIGNMENT



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



ON Semiconductor

http://onsemi.com

MARKING DIAGRAMS 16



CDIP-16 L SUFFIX CASE 620





PDIP-16 P SUFFIX CASE 648





PLCC-20 FN SUFFIX CASE 775



A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping		
MC10111L	CDIP-16	25 Units / Rail		
MC10111P	PDIP-16	25 Units / Rail		
MC10111FN	PLCC-20	46 Units / Rail		

ELECTRICAL CHARACTERISTICS

			Test Limits							
		Pin Under	-30	D°C		+25°C		+85	5°C	
Characteristic	Symbol	Test	Min	Max	Min	Тур	Max	Min	Max	Unit
Power Supply Drain Current	ΙE	8		42		30	38		42	mAdo
Input Current	I _{inH}	5, 6, 7		680			425		425	μAdc
	I _{inL}	5, 6, 7	0.5		0.5			0.3		μAdc
Output Voltage Logic 1	V _{OH}	2	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc
		3 4	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	
Output Voltage Logic 0	V _{OL}	2	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc
catput voltage Logic o	• OL	3	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	• 40
		4	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	
Threshold Voltage Logic 1	V_{OHA}	2 3	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		Vdc
		4	-1.080		-0.980			-0.910	0	
Threshold Voltage Logic 0	V _{OLA}	2		-1.655			-1.630	,(-1.595	Vdc
		3		-1.655			-1.630		-1.595 -1.595	
Cuitabina Tinana (FOC Land)		4		-1.655			-1.630		-1.595	
Switching Times (50Ω Load)			A 4	0.5		0.4	0.5		0.0	ns
Propagation Delay	t ₅₊₂₋ t ₅₋₂₊	2 2	1.4 1.4	3.5 3.5	1.4 1.4	2.4 2.4	3.5 3.5	1.5 1.5	3.8 3.8	
	t ₅₊₃₋	3	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
	t _{5–3+} t _{5+4–}	3 4	1.4 1.4	3.5 3.5	1.4 1.4	2.4 2.4	3.5 3.5	1.5 1.5	3.8 3.8	
	t ₅₋₄₊	4	1.4	3.5	1.4	2.4	3.5	1.5	3.8	
Rise Time (20 to 80%)	t ₂₊	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	t ₃₊ t ₄₊	3 4	1.0 1.0	3.5 3.5	13	2.2 2.2	3.5 3.5	1.2 1.2	3.8 3.8	
Fall Time (20 to 80%)	ta	2	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
(20 to 00%)	t ₃₋	3	1.0	3.5	10	2.2	3.5	1.2	3.8	
	t ₄₋	4	1.0	3.5	1.1	2.2	3.5	1.2	3.8	
	tg- tg- tg- t4-	.119			7					
		41,7								
			15/							
	C	1.00								
		S.V								

ELECTRICAL CHARACTERISTICS (continued)

				TEST VO	LTAGE VALU	JES (Volts)		
	@ Test Te	mperature	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	
		-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
		+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
		+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
		Pin	TEST VOLTAGE APPLIED TO PINS LISTED BELOW					
Characteristic	Symbol	Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}	(V _{CC}) Gnd
Power Supply Drain Current	ΙE	8					8	1, 15, 16
Input Current	I _{inH}	5, 6, 7	*				8	1, 15, 16
	I _{inL}	5, 6, 7		*			8	1, 15, 16
Output Voltage Logic	1 V _{OH}	2 3 4					8 8	1, 15, 16 1, 15, 16 1, 15, 16
Output Voltage Logic	0 V _{OL}	2 3 4	5 6 7		>	. (0	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Threshold Voltage Logic	1 V _{OHA}	2 3 4				5 6 7	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Threshold Voltage Logic	0 V _{OLA}	2 3 4		SSC	5 6 7	2012	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16
Switching Times (50Ω Loa	d)			O_{Λ}	Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	t ₅₊₂₋ t ₅₋₂₊ t ₅₊₃₋ t ₅₋₃₊ t ₅₊₄₋ t ₅₋₄₊	2 2 3 3 4 4	ICE IS	ROM	5 5 5 5 5 5	2 2 3 3 4 4	8 8 8 8 8	1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16
Rise Time (20 to 809) Fall Time (20 to 809)	t ₃₊ t ₄₊	2 3 4	TAI		5 5 5	2 3 4 2	8 8 8	1, 15, 16 1, 15, 16 1, 15, 16 1, 15, 16
	t ₃₋ t ₄₋	3 4			5 5	3 4	8 8	1, 15, 16 1, 15, 16

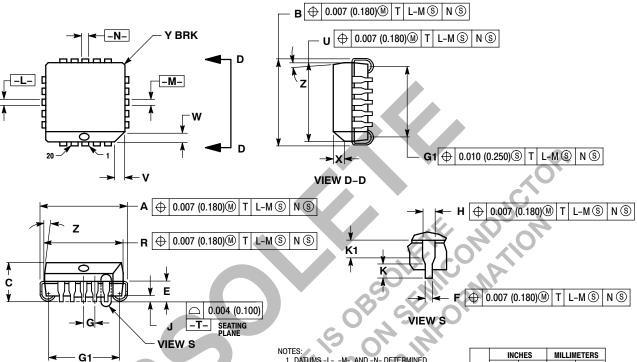
^{*} Individually test each input using the pin connections shown.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

PACKAGE DIMENSIONS

PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 **ISSUE C**



0.010 (0.250) T L-M N N

- IOTES:

 1. DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS PLASTIC
 BODY AT MOLD PARTING LINE.

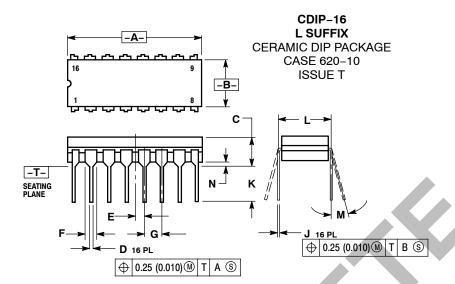
 2. DIMENSION 61, TRUE POSITION TO BE
 MEASURED AT DATUM -T-, SEATING PLANE.

 3. DIMENSIONS R AND U DO NOT INCLUDE MOLD
 FLASH: ALLOWABLE MOLD FLASH IS 0.010 (0.250)
 DED SIGN

- PER SIDE.
 DIMENSIONING AND TOLERANCING PER ANSI
- 714.5M, 1982.
 5. CONTROLLING DIMENSION: INCH.
 6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO .0.12 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP
- AND BOTTOM OF THE PLASTIC BODY.
 DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
С	0.165	0.180	4.20	4.57	
Ε	0.090	0.110	2.29	2.79	
F	0.013	0.019	0.33	0.48	
G	0.050	BSC	1.27	BSC	
Н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
K	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
٧	0.042	0.048	1.07	1.21	
W	0.042	0.048	1.07	1.21	
Х	0.042	0.056	1.07	1.42	
Υ		0.020		0.50	
Z	2°	10°	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		

PACKAGE DIMENSIONS

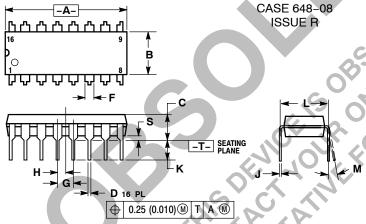


NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
- DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
H	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62 BSC		
M	0°	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MIN MAX		MAX	
PΑ	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

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